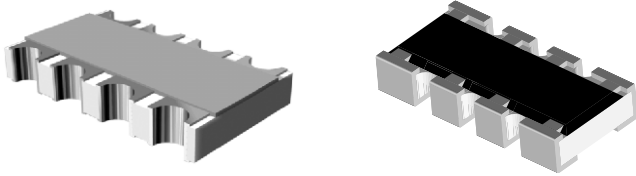


Precision Thin Film Chip Resistor Array



ACAC 0612 (concave terminations) and ACAS 0612 (convex terminations) thin film chip resistor arrays combine the proven reliability of precision thin film chip resistor products with the advantages of chip resistor arrays. Defined tolerance matching and TCR tracking make this product perfectly suited for applications with outstanding requirements towards stable fixed resistor ratios. A small package enables the design of high density circuits in combination with reduction of assembly costs. Four equal resistor values or two pairs are available.

FEATURES

- Advanced thin film technology
- Two pairs or four equal resistor values
- TCR tracking down to 10 ppm/K (± 5 ppm/K)
- Tolerance matching down to 0.1 % (± 0.05 %)
- Pure Sn termination on Ni barrier layer
- Compliant to RoHS directive 2002/95/EC



RoHS
COMPLIANT

APPLICATIONS

- Precision analogue circuits
- Voltage divider
- Feedback circuits
- Signal conditioning

TECHNICAL SPECIFICATIONS	
DESCRIPTION	ACAC 0612, ACAS 0612
EIA size	0612
Metric size	RR 1632M
Configuration, isolated	4 x 0603
Design:	
All equal	AE
Two pairs	TP
Resistance values	47 Ω to 221 k Ω ⁽¹⁾
Absolute tolerance	± 0.5 %; ± 0.25 %
Tolerance matching ⁽²⁾	0.5 % (equivalent to ± 0.25 %) 0.25 % (equivalent to ± 0.125 %) 0.1 % (equivalent to ± 0.05 %)
Absolute temperature coefficient	± 50 ppm/K; ± 25 ppm/K
Temperature coefficient tracking ⁽²⁾	50 ppm/K (equivalent to ± 25 ppm/K) 25 ppm/K (equivalent to ± 12.5 ppm/K) 15 ppm/K (equivalent to ± 7.5 ppm/K) 10 ppm/K (equivalent to ± 5 ppm/K)
Max. resistance ratio $R_{min.}/R_{max.}$	1:5
Rated dissipation: P_{70} ⁽³⁾	
Element	0.1 W
Package, 4 x 0603	0.3 W
Operating voltage	75 V
Permissible film temperature	125 $^{\circ}$ C ⁽⁴⁾
Insulation voltage (U_{ins}) against ambient and between isolated resistors, continuous	75 V

Notes

- (1) Resistance values to be selected from E24 and E96
- (2) In applications with defined resistance ratios like voltage dividers or feedback circuits, an array with a defined tracking of e.g. 10 ppm/K is required to replace discrete resistors with a temperature coefficient of resistance of ± 5 ppm/K. Furthermore, in order to achieve the same tolerance of ± 0.05 % of individual resistors, an array requires a matching of 0.1 %.
- (3) Please refer to APPLICATION INFORMATION, see below
- (4) For higher max. film temperature and AEC-Q200 qualification please refer to data sheet ACAS 0606 AT, ACAS 0612 AT - Precision available on our web site at www.vishay.com/doc?28770

APPLICATION INFORMATION

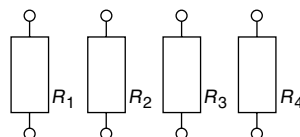
The power dissipation on the resistor generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature is not exceeded. These resistors do not feature a limited lifetime when operated within the permissible limits.

MAXIMUM RESISTANCE CHANGE AT RATED POWER ⁽¹⁾			
DESCRIPTION	ACAC 0612, ACAS 0612		
Configuration, isolated	4 x 0603		
Operation mode	Precision	Standard	
Rated power per element, P_{70}	0.032 W	0.1 W	
Rated power per packaging, P_{70}	0.1 W	0.3 W	
Film temperature	85 °C	125 °C	
Operating voltage, U_{max} AC/DC	25 V	75 V	
Max. resistance change at P_{70} $\Delta R/R$ max., after:	1000 h	± 0.1 %	± 0.25 %
	8000 h	± 0.25 %	± 0.5 %
Max. relative resistance change (relative drift) at P_{70} $\Delta R/R$ max., after:	1000 h	0.1 % ⁽²⁾	0.25 % ⁽³⁾
	8000 h	0.25 % ⁽³⁾	0.5 % ⁽⁴⁾

Notes

- (1) Figures are given for arrays with equal values, design type AE
- (2) Equivalent to ± 0.05 %
- (3) Equivalent to ± 0.125 %
- (4) Equivalent to ± 0.25 %

SKETCHES



ACAC 0612, ACAS 0612

DESIGN	
TYPE	ACAC 0612, ACAS 0612
AE	$R_1 = R_2 = R_3 = R_4$
TP	$R_1 = R_4 < R_2 = R_3$

PART NUMBER AND PRODUCT DESCRIPTION (1)																	
PART NUMBER: ACASA1100A2200P500																	
A	C	A	S	A	1	1	0	0	A	2	2	0	0	P	5	0	0
MODEL	TERMINAL	SIZE	RESISTANCE VALUE (2)	ACCURACY GRADE (3)	RESISTANCE VALUE (2)	PACKAGING (4)	SPECIAL										
ACA	C = Concave S = Convex square	A = 0612	3 digit resistance value R_1, R_4 1 digit multiplier MULTIPLIER 9 = $\times 10^{-1}$ 0 = $\times 10^0$ 1 = $\times 10^1$ 2 = $\times 10^2$ 3 = $\times 10^3$	TCR, tracking, tolerance and matching A, B, E, F, J, K, N or P	3 digit resistance value R_2, R_3 1 digit multiplier MULTIPLIER 9 = $\times 10^{-1}$ 0 = $\times 10^0$ 1 = $\times 10^1$ 2 = $\times 10^2$ 3 = $\times 10^3$	P1 P5	00 = Standard										
PRODUCT DESCRIPTION: ACAS 0612 110R A 220R P5																	
ACA	S	0612	110R	A	220R	P5											
MODEL	TERMINATION	SIZE	RESISTANCE VALUE R_1, R_4 (2)	ACCURACY GRADE (3)	RESISTANCE VALUE R_2, R_3 (2)	PACKAGING (4)											
ACA = Chip array	C = Concave S = Convex square	0612	110R = 110 Ω 1K1 = 1.1 k Ω 22K1 = 22.1 k Ω	TCR, tracking, tolerance and matching A, B, E, F, J, K, N or P	220R = 220 Ω 1K1 = 1.1 k Ω 22K1 = 22.1 k Ω	P1 P5											

Notes

- (1) Products can be ordered using either the PART NUMBER or the PRODUCT DESCRIPTION
- (2) $R_1 = R_4 \leq R_2 = R_3$
- (3) Please refer to table TEMPERATURE COEFFICIENT AND RESISTANCE RANGE, see below
- (4) Please refer to table PACKAGING, see next page

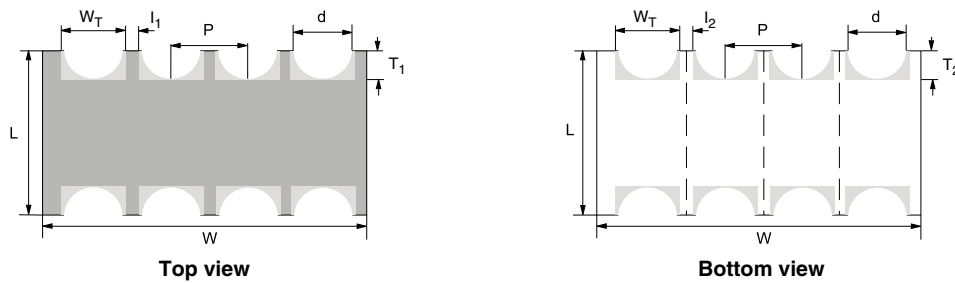
TEMPERATURE COEFFICIENT AND RESISTANCE RANGE					
DESCRIPTION					RESISTANCE VALUE
ACCURACY GRADE	ABSOLUTE TCR	TCR TRACKING (5)	ABSOLUTE TOLERANCE	TOLERANCE MATCHING (5)	ACAC 0612, ACAS 0612
A	± 25 ppm/K	10 ppm/K	± 0.25 %	0.1 %	47 Ω to 221 k Ω
B	± 25 ppm/K	10 ppm/K	± 0.5 %	0.25 %	47 Ω to 221 k Ω
E	± 25 ppm/K	15 ppm/K	± 0.25 %	0.1 %	47 Ω to 221 k Ω
F	± 25 ppm/K	15 ppm/K	± 0.5 %	0.25 %	47 Ω to 221 k Ω
J	± 25 ppm/K	25 ppm/K	± 0.25 %	0.1 %	47 Ω to 221 k Ω
K	± 25 ppm/K	25 ppm/K	± 0.5 %	0.25 %	47 Ω to 221 k Ω
N	± 50 ppm/K	25 ppm/K	± 0.5 %	0.5 %	47 Ω to 221 k Ω
P	± 50 ppm/K	50 ppm/K	± 0.5 %	0.5 %	47 Ω to 221 k Ω

Note

- (5) Please refer to TECHNICAL SPECIFICATIONS, Note (2), see above

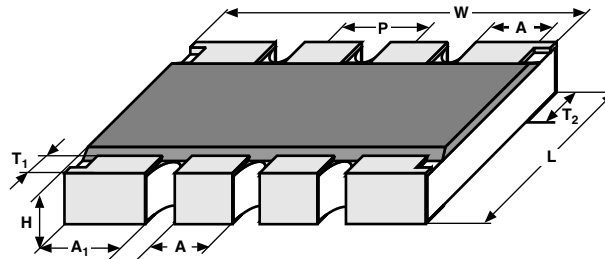
PACKAGING					
MODEL	TAPE WIDTH	DIAMETER	PIECES	PITCH	PACKAGING CODE
					PAPER TAPE
ACAC 0612 ACAS 0612	8 mm	180 mm/7"	1000	4 mm	P1
	8 mm	180 mm/7"	5000	4 mm	P5

DIMENSIONS ACAC 0612



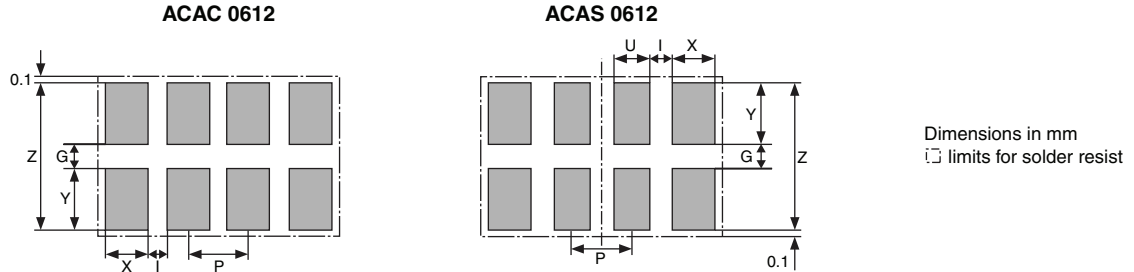
DIMENSIONS - Chip resistor array, mass and relevant physical dimensions											
TYPE	L (mm)	W (mm)	H (mm)	P (mm)	WT (mm)	T ₁ (mm)	T ₂ (mm)	d (mm)	l ₁ (mm)	l ₂ (mm)	MASS (mg)
ACAC 0612	1.6 ± 0.15	3.2 ± 0.15	0.55 ± 0.1	0.8 ± 0.1	0.5 ± 0.15	0.3 ± 0.15	0.4 ± 0.15	0.3 ± 0.1	min. 0.15	min. 0.25	9.6

DIMENSIONS ACAS 0612



DIMENSIONS - Chip resistor array, mass and relevant physical dimensions									
TYPE	L (mm)	W (mm)	H (mm)	P (mm)	A ₁ (mm)	A (mm)	T ₁ (mm)	T ₂ (mm)	MASS (mg)
ACAS 0612	1.5 ± 0.15	3.2 ± 0.15	0.45 ± 0.1	0.8 ± 0.1	0.6 ± 0.1	0.4 ± 0.1	0.3 ± 0.15	0.4 ± 0.15	6.6

PATTERN STYLES FOR CHIP RESISTOR ARRAYS



RECOMMENDED SOLDER PAD DIMENSIONS FOR CHIP RESISTOR ARRAYS							
TYPE	G (mm)	Y (mm)	X (mm)	U (mm)	Z (mm)	I (mm)	P (mm)
ACAC 0612	0.7	0.7	0.5	-	2.1	0.3	0.8
ACAS 0612	0.7	0.7	0.64	0.5	2.1	0.3	0.8

DESCRIPTION

The production of the components is strictly controlled and follows an extensive set of instructions established for reproducibility. A homogeneous film of metal alloy is deposited on a high grade (96 % Al₂O₃) ceramic substrate using a mask to separate the adjacent resistors and conditioned to achieve the desired temperature coefficient. Specially designed inner contacts are realized on both sides. A special laser is used to achieve the target value by smoothly cutting a meander groove in the resistive layer without damaging the ceramics.

The resistor elements are covered by a protective coating designed for electrical, mechanical and climatic protection. The terminations receive a final pure tin on nickel plating.

The result of the determined production is verified by an extensive testing procedure and optical inspection performed on 100 % of the individual chip resistors. Only accepted products are laid directly into the paper tape in accordance with IEC 60286-3⁽³⁾.

ASSEMBLY

The resistors are suitable for processing on automatic SMD assembly systems. They are suitable for automatic soldering using reflow or vapour phase as shown in IEC 61760-1⁽³⁾. For ACAC resistor arrays automatic soldering using wave can also be used. The encapsulation is resistant to all cleaning solvents commonly used in the electronics industry, including alcohols, esters and aqueous solutions.

The suitability of conformal coatings, if applied, shall be qualified by appropriate means to ensure the long-term stability of the whole system. The resistors are RoHS compliant; the pure tin plating provides compatibility with lead (Pb)-free and lead-containing soldering processes. The permitted storage time is 20 years, whereas the solderability is specified for 2 years after production or requalification. The immunity of the plating against tin whisker growth has been proven under extensive testing.

All products comply with the GADSL⁽¹⁾ and the CEFIC-EECA-EICTA⁽²⁾ list of legal restrictions on hazardous substances. This includes full compliance with the following directives:

- 2000/53/EC End of Vehicle life Directive (ELV) and Annex II (ELV II)
- 2002/95/EC Restriction of the use of Hazardous Substances directive (RoHS)
- 2002/96/EC Waste Electrical and Electronic Equipment Directive (WEEE)

TESTS

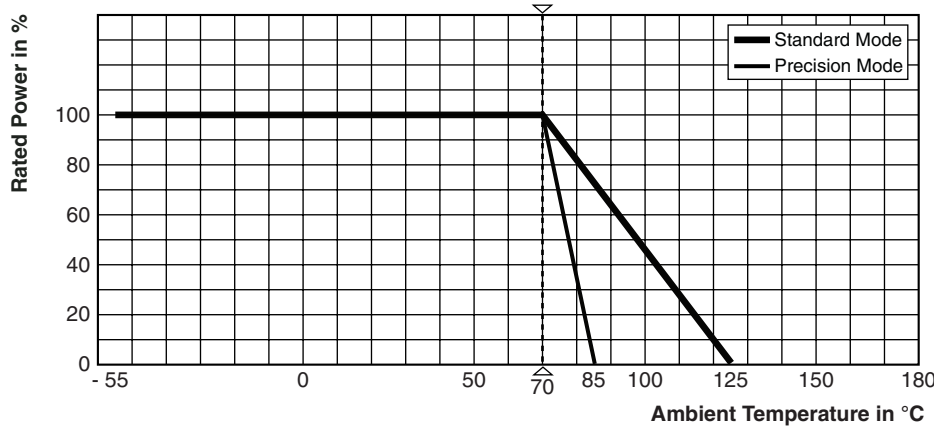
Where applicable, the resistors are tested in accordance with EN 140401-801 which refers to EN 60115-1 and EN 140400.

Notes

(1) Global Automotive Declarable Substance List, see www.gadsl.org
 (2) CEFIC (European Chemical Industry Council), EECA (European Electronic Component Manufacturers Association), EICTA (European trade organisation representing the information and communications technology and consumer electronics), see www.eicta.org → policy → environmental policy group → chemicals → jig → Joint Industry Guide (JIG-101 Ed 2.0)
 (3) The quoted IEC standards are also released as EN standards with the same number and identical contents



FUNCTIONAL PERFORMANCE



For permissible resistance change please refer to table MAXIMUM RESISTANCE CHANGE AT RATED POWER

Derating

TESTS AND REQUIREMENTS

Essentially all tests are carried out in accordance with the following specifications:

EN 60115-1, generic specification

EN 140400, sectional specification

EN 140401-801, detail specification

The testing also covers most of the requirements specified by EIA/IS-703 and JIS-C-5202.

The tests are carried out in accordance with IEC 60068 (1) and under standard atmospheric conditions according to IEC 60068-1 (1), 5.3. Climatic category LCT/UCT/56 (rated temperature range: Lower Category Temperature, Upper

Category Temperature; damp heat, long term, 56 days) is valid (LCT = - 55 °C/UCT = 125 °C).

Unless otherwise specified the following values apply:

Temperature: 15 °C to 35 °C

Relative humidity: 45 % to 75 %

Air pressure: 86 kPa to 106 kPa (860 mbar to 1060 mbar)

The requirements stated in the “Test Procedures and Requirements” table are based on the required tests and permitted limits of EN 140401-801 where applicable.

TEST PROCEDURES AND REQUIREMENTS				
EN 60115-1 CLAUSE	IEC 60068-2 (1) TEST METHOD	TEST	PROCEDURE	REQUIREMENTS (2) PERMISSIBLE CHANGE (ΔR)
			Stability for product types: ACAC 0612 ACAS 0612	47 Ω to 221 kΩ 47 Ω to 221 kΩ
4.5	-	Resistance	-	± 0.5 % R; ± 0.25 % R
4.8.4.2	-	Temperature coefficient	At (20/-55/20) °C and (20/125/20) °C	± 50 ppm/K; ± 25 ppm/K

TEST PROCEDURES AND REQUIREMENTS				
EN 60115-1 CLAUSE	IEC 60068-2 (1) TEST METHOD	TEST	PROCEDURE	REQUIREMENTS (2) PERMISSIBLE CHANGE (ΔR)
			Stability for product types: ACAC 0612 ACAS 0612	47 Ω to 221 k Ω 47 Ω to 221 k Ω
4.25.1	-	Endurance at 70 °C: Precision operation mode	$U = \sqrt{P_{70} \times R}$ or $U = U_{max.}$; 1.5 h on; 0.5 h off; 1000 h: Absolute Relative (3) 8000 h: Absolute Relative (3)	$\pm (0.1 \% R + 0.05 \Omega)$ 0.1 % $R + 0.05 \Omega$ $\pm (0.25 \% R + 0.05 \Omega)$ 0.25 % $R + 0.05 \Omega$
		Endurance at 70 °C: Standard operation mode	$U = \sqrt{P_{70} \times R}$ or $U = U_{max.}$; 1.5 h on; 0.5 h off; 1000 h: Absolute Relative (3) 8000 h: Absolute Relative (3)	$\pm (0.25 \% R + 0.05 \Omega)$ 0.25 % $R + 0.05 \Omega$ $\pm (0.5 \% R + 0.05 \Omega)$ 0.5 % $R + 0.05 \Omega$
4.25.3	-	Endurance at upper category temperature	85 °C; 1000 h: Absolute Relative (3) 125 °C; 1000 h: Absolute Relative (3)	$\pm (0.1 \% R + 0.05 \Omega)$ 0.1 % $R + 0.05 \Omega$ $\pm (0.25 \% R + 0.05 \Omega)$ 0.25 % $R + 0.05 \Omega$
4.24	78 (Cab)	Damp heat, steady state	(40 \pm 2) °C; 56 days; (93 \pm 3) % RH	$\pm (0.25 \% R + 0.05 \Omega)$
4.13	-	Short time overload (4)	$U = 2.5 \times \sqrt{P_{70} \times R}$ or $U = 2 \times U_{max.}$; 5 s	$\pm (0.1 \% R + 0.01 \Omega)$ no visible damage
4.19	14 (Na)	Rapid change of temperature	30 min at - 55 °C and 30 min at 125 °C; 5 cycles	$\pm (0.1 \% R + 0.01 \Omega)$ no visible damage
4.18.2	58 (Td)	Resistance to soldering heat	Reflow method 2 (IR/forced gas convection); (260 \pm 5) °C; (10 \pm 1) s	$\pm (0.1 \% R + 0.01 \Omega)$ no visible damage
4.17.2	58 (Td)	Solderability	Solder bath method; SnPb; non-activated flux accelerated ageing 4 h/155 °C (215 \pm 3) °C; (3 \pm 0.3) s	Good tinning (\geq 95 % covered); no visible damage
			Solder bath method; SnAgCu; non-activated flux accelerated ageing 4 h/155 °C (235 \pm 3) °C; (2 \pm 0.2) s	



TEST PROCEDURES AND REQUIREMENTS				
EN 60115-1 CLAUSE	IEC 60068-2 (1) TEST METHOD	TEST	PROCEDURE	REQUIREMENTS (2) PERMISSIBLE CHANGE (ΔR)
			Stability for product types: ACAC 0612 ACAS 0612	47 Ω to 221 k Ω 47 Ω to 221 k Ω
4.32	21 (Ue ₃)	Shear (adhesion)	45 N	No visible damage
4.33	21 (Ue ₁)	Substrate bending	Depth 2 mm, 3 times	$\pm (0.1 \% R + 0.01 \Omega)$ no visible damage; no open circuit in bent position
4.7	-	Voltage proof	$U_{RMS} = U_{ins}$ (60 \pm 5) s; against ambient, between adjacent resistors	No flashover or breakdown

Notes

- (1) The quoted IEC standards are also released as EN standards with the same number and identical contents
- (2) Figures are given for arrays with equal values, design type AE
- (3) Relative values are equivalent to the half of its value with \pm symbol, i.e. 0.1 % is equivalent to ± 0.05 %
- (4) For a single element



Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk and agree to fully indemnify and hold Vishay and its distributors harmless from and against any and all claims, liabilities, expenses and damages arising or resulting in connection with such use or sale, including attorneys fees, even if such claim alleges that Vishay or its distributor was negligent regarding the design or manufacture of the part. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.